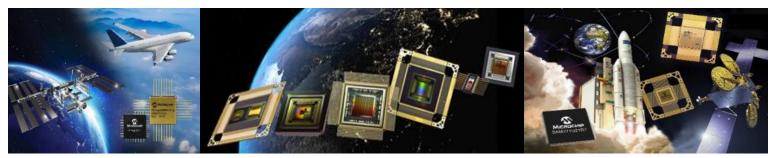


Facing New Space Challenges European Scalable Solutions



A Leading Provider of Smart, Connected and Secure Embedded Control Solutions



Nicolas GANRY - Microchip France ESCCON - 9th Mar 2023



Facing New Space Challenges

- Microchip Aerospace & Defense in Europe
- New Space Challenges @semiconductors
- Microchip Scalable Solutions in Europe



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A&D Product Lines in Europe









Advanced Packaging UK

 Expertise in miniaturisation vs. size, power and reliability

ADG France

- ✓ Mixed Signal ASIC
- ✓ Processors and Microcontrollers
- ✓ Com interfaces and Memories
- DPM France
 ✓ Power Modules
- DPM Ireland
 ✓ Hi-Reliability Discrete
 ✓ Power Modules
- Vectron Germany
 - ✓ Oscillators✓ RF SAW Filters
- RF Microwave UK
 ✓ Amplifiers —

A CONIC RF





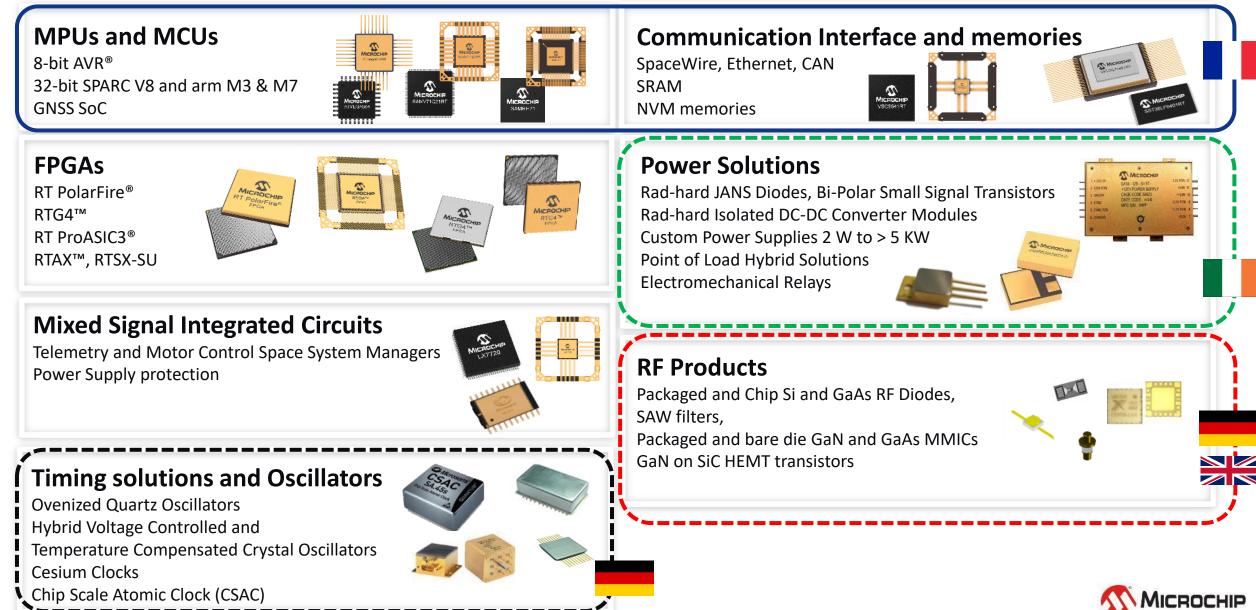




Teltow & Neckarbischofsheim, Germany



Largest Space Semiconductors Portfolio



Part of European Space Ecosystem





- More than 35 years history and unrivalled flight heritage
- Member of different ESA control boards and working groups
- Supported by local agencies CNES, DGA (FR), DLR (GER), UK Govt
- Contributing to European Commission funded programs
- ESCC / DLA Qualified Supply Chain in France, Ireland & Germany (target)





Processing : An Unrivalled Flight Heritage



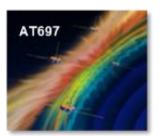
Colombus 2008



SVOM/Eclair 2013



Proba2 2009



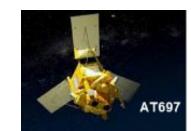
MMS (Nasa) 2014



JUNO (Nasa) 2011



Exomars 2016



SPOT6 2012



Solar Obiter 2017



Bepi-Colombo

2018

4 T 6 9'

AT7913

AT697

Gaïa

2013

Capella Sequoia Earth Obs 2020

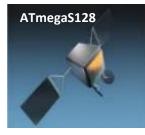


Sentinels & Alphasat 2013



Perseverance 2021

SAM3X8ERT



Thousands of flight models delivered worldwide

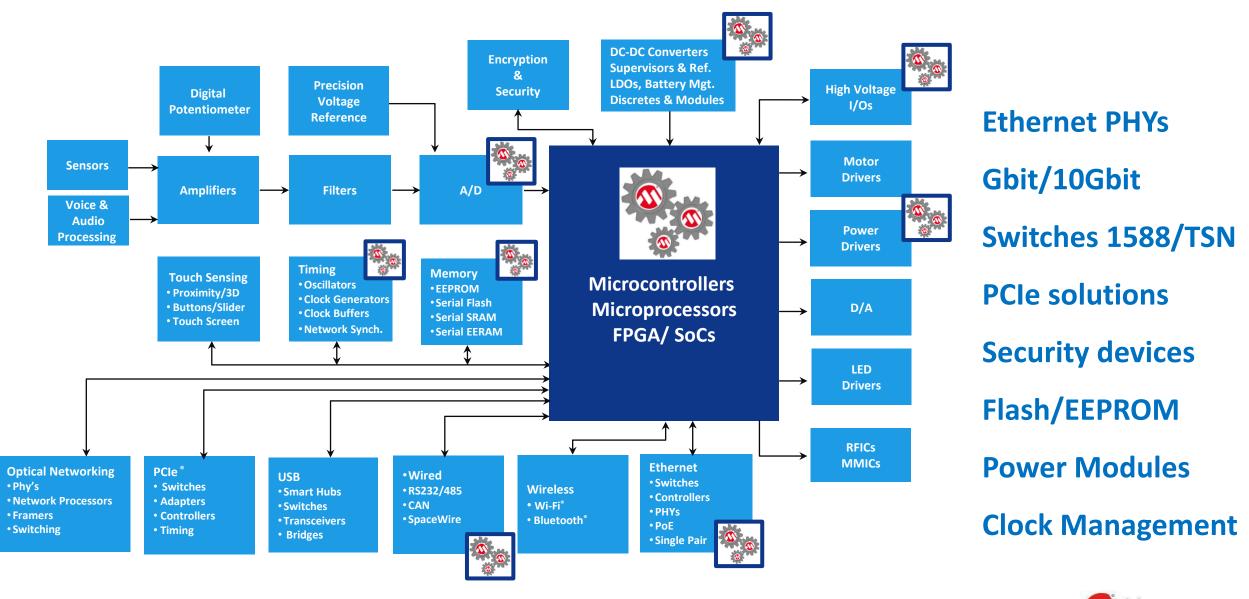
Mega Constellation

7 LEO Sat -2019

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Drive innovation around processing solutions



MICROCHIP

Facing New Space Challenges

- Microchip Aerospace & Defense in Europe
- New Space Challenges @semiconductors
- Microchip Scalable Solutions in Europe



New Space Challenges / Semiconductors

- Cost reduction (but still low volume)
 - Recurrent costs @component level (RE)
 - Development costs @system level (NRE)
- Development lead time pull in
 - Driven by a shorter time ROI
- Performances & Quality leverage
 - Depending on mission, duration, orbit but also risk management
- New actors coming from industrial/automotive
 - Looking for easy access solution with known technology (eg. Ethernet)
 - Bidding on different opportunities from class 1 space agencies program to mega LEO small sat constellations.
- Semiconductors technology driven by commercial with more advanced technologies & « System on Chip » => more SEE events and higher access costs



Space evolution w Microchip

Hirel Plastic * Rad Tolerant * Rad Hard



Commercial leadership

- Very high-volume COTS supplier
- MCU & FPGA Market leader
- Connectivity Ethernet
- Security

• Leader in Space

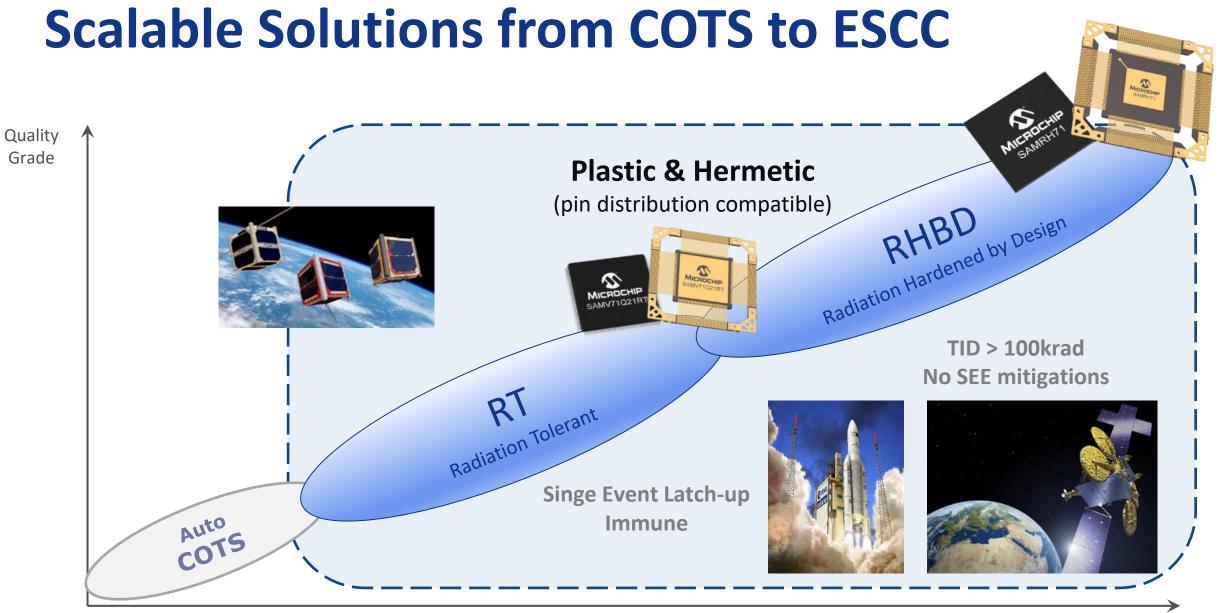
- Number 1 for Semiconductors
- Strong flight heritage
- Radiation expertise
- JANS/ QML/ ESCC portfolio
- Customization capabilities
 - Bridge from COTS to RT
 - Bridge from QML to Sub QML
 - Scalability



Facing New Space Challenges

- Microchip Aerospace & Defense in Europe
- New Space Challenges @semiconductors
- Microchip Scalable Solutions in Europe





Temperature performances

Radiation performances



Hirel Plastic vs COTS Automotive

- Ensure full traceability : Single Fab & Assembly w Dedicated Wafers
- Access to « Single Lot Date Code »
- Extended temperature range -55/125°C*
- Low MOQ : hundred of units
- Reliability verified on the full temperature range
- Extended qualification : HAST, Life Tests, Temp Cycling ... => prod spec & CofC
- Full access to Qualification Data (Qual Pack)
- Extra screening options : burnin, T° cycling, ...
- Extension towards QMLP ESCC900P standard qualification level

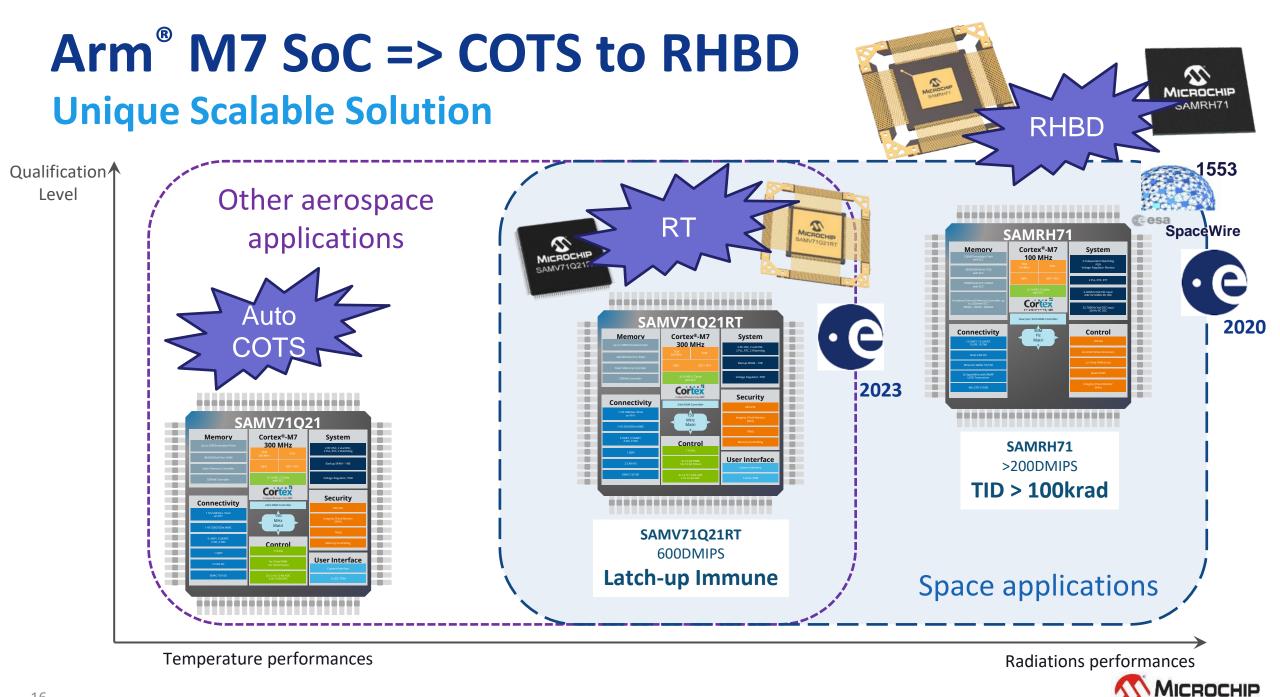


COTS to space qualified RT @Microchip

- 1. Identify industry needs, share roadmaps & input from other domains (eg. auto)
- 2. Select device in the Microchip's portfolio
 - Select the best Design/Technology couple. Based on our experience, we select potential winners.
- 3. Assess the device by simulation against SEE and TID using :
 - Based Technology information (Foundries)
 - And Design data base (GDSII)
- 4. Radiations Tests / defined boundary conditions
 - TID : To characterize the product capability
 - SEE : To evaluate destructive events Single Event Latchup - Single Event Gate Rupture - Single Event Burnout
- 5. Product improvements towards RT level (process, fix, spec, ...)
- 6. Qualification for space applications including radiations (SEU & TID)
 - SEU : Characterization of all functional blocks of the device
 - Space qualification according to space standards / Ceramic & Plastic
- 7. RT datasheet, radiation report and mitigation guidelines
- 8. Introduce and support COTS RT on space market w a dedicated team
- 9. Products belongs to French Export Control when all activities done in France







Scalable & Plastic solutions from ADG

COTS Rad Tolerant

Products	Туре	Summary / Highlights	Flight Models	
ATmegaS128	MCU AVR8	~10 DMIPS, SPI,TWI, UART, ADC	Feb 2017	Mendana Antigentitation
ATmegaS64M1	MCU AVR8	~10 DMIPS, CAN, DAC and Motor Control	Dec 2017	
SAMV71Q21RT	MCU ARM M7	600 DMIPS, CAN FD, Ethernet TSN, DSP	Dec 2018	Cesa MICROCHIE SANV71021RT
SAM3X8ERT	MCU ARM M3	100 DMIPS, CAN, Ethernet, Dual CAN	Apr 2020	ines a
VSC8541RT	Ethernet PHY	100Mb/1Gbit Ethernet Transceiver, RMII/RGMII	Sep 2020	MICROCHIP VSCB541RT
SST38LF6401RT	Parallel Flash	64 Mbit Parallel Rad Tolerant Flash Memory	Oct 2021	
SST26LF064RT	Serial Flash	64 Mbit Serial Rad Tolerant Flash Memory	Nov 2022	Station

Rad Hard by Design

Products	RH Techno	Summary / Highlights	Flight Models		SAMRH71
SAMRH71 MPU	ATMX150RHA	Arm Cortex-M7, >200 DMIPS Spw/1553/CAN FD/Eth, TCM/FPU/MPU/ECC	Dec 2020 ESCC9512006	cnes	
SAMRH707 MCU "Jaguar"	ATMX150RHA	Arm Cortex-M7, 100 DMIPS Spw/1553/CAN FD, ADC/DAC, NVM+, small package	FM Q2 2023	esa	



J.

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MCHP "L" Series Oscillators

• Address unique "4R" requirements

- Radiation 50krad and below, SEE 60 MeV-cm2/mg and below
- Reliability Commercial to military assembly and screening
- **R**ating Commercial or military grade components
- **R**uggedization Design and construction to survive launch and mission profile

Oscillators Families

- LX-703 XO, X-tal Oscillator (Clock)
- LT-400 TCXO Temperature Compensated X-tal Oscillator
- LT-802 TCXO Temperature Compensated X-tal Oscillator
- LO-200 OCXO Oven Controlled X-tal Oscillator
- LM-010 PPS Module
- All oscillators radiation tested as a complete, functioning oscillator for TID

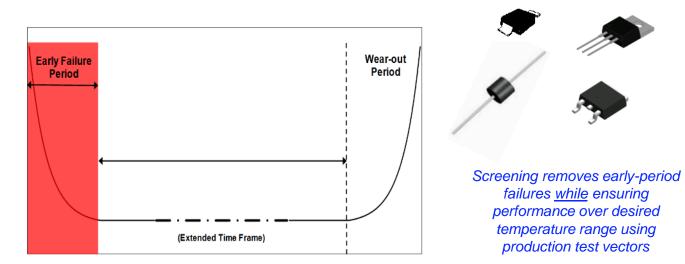


Discretes : Microchip New Space (MNS) Flow

• Objective

 Create versions diodes and transistors that can meet aggressive price targets to serve New Space programs that will not use traditional JANS and JANTXV devices

- Requirements
 - Reduction in cost and price
 - Shorter lead-time and cycle-time



- Microchip Discrete Solutions
 - Microchip New Space (MNS) Flow Hermetic and non-hermetic options
 - Hermetic MNS flow -> Military Temperature Screening, PIND, Group A and D
 - Non-Hermetic / Plastic MNS flow -> Military Temperature Screening, Group A and D



Time is the Essence of New Space

Reducing development costs leads to reduce development cycles

Microchip proposes « System Use Cases » to boost your development lead times & ease your system design:

- > Suggesting a list of Microchip components working together
- Providing hardware example associating some Microchip components
- Developing software examples to interact with one or more Microchip components
- > Demonstrating application use cases at system level
- Offering application notes, tools and presentations to ease customer system integration with Microchip components





Motor Control in Space

Brushless DC Motors (BLDC - PMSM): Solar panel control, Valve control

Stepper Motors: Antenna control, on board camera, Solar panel control, Open loop micro-positioning





Summary – New Space Challenges

• Microchip A&D product lines in Europe

- Contributing to largest space products portfolio
- Drive space system innovation around processing solutions
- New Space Challenges / Semiconductors
 - Costs, Schedules, ROI, New players, Technology trend, ...

• Scalable Solutions for New Space in Europe

- COTS upgrade to qualified plastic & ceramic for space
- Solutions from Europe : MCU/MPU, Ethernet, Flash, Oscillators & discretes.
- System use cases to reduce development lead times





Thank You

New Space Web

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